

DF.DEL003A



PATENT

AP/JRW
1/8/05
JRW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant :	Chen Chun Chen and Chih Chiang Lin)	
Appl. No. :	10/075,059)	
Filed :	February 11, 2002)	I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on <u>Thursday, January 06, 2005</u> (Date)
For :	STRUCTURE OF GROUND PIN FOR AC INLET AND PROCESS FOR FASTENING WIRE ONTO SAME)	
Examiner :	Ross N. Gushi)	
Group Art Unit:	2833)	

27299

PATENT TRADEMARK OFFICE

Robert F. Gazdzinski
Reg. No. 39,990

AFTER-FINAL AMENDMENT AND RESPONSE

**Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

Dear Sir:

In response to the final Office Action dated August 18, 2004 ("Office Action"), and the Advisory Action dated December 21, 2004 ("Advisory Action"), the following is provided: